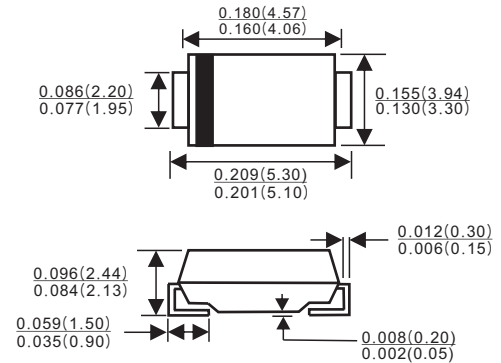




**REVERSE VOLTAGE: 50 - 1000 V**  
**FORWARD CURRENT: 2.0 A**

**SMB/DO-214AA**



Dimensions in inches and(millimeters)

### Features

- ✧ Plastic package has underwriters laboratories flammability classification 94V-0
- ✧ For surface mount applications
- ✧ Glass passivated chip junctions
- ✧ Low profile package
- ✧ Easy pick and place
- ✧ Ultrafast recovery times for high efficiency
- ✧ Low forward voltage,low power loss
- ✧ Built-in strain relief,ideal for automated placement
- ✧ High temperature soldering:  
250°C/10 seconds on terminals

### Mechanical Data

- ✧ Case:JEDEC DO-214AA,molded plastic body over passivated chip
- ✧ Polarity: Color band denotes cathode end
- ✧ Weight: 0.003 ounces, 0.093 gram

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

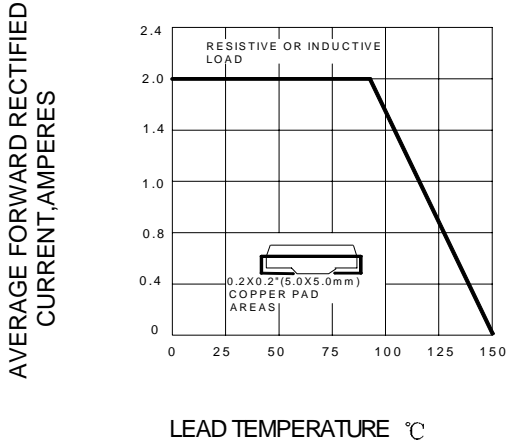
Parameter	Symbol	US2AB	US2BB	US2DB	US2GB	US2JB	US2KB	US2MB	UNITS	
Marking code		US2A	US2B	US2D	US2G	US2J	US2K	US2M		
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V	
Maximum RMS voltage	$V_{RWS}$	35	70	140	280	420	560	700	V	
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V	
Maximum average forward rectified current @ $T_L=90^\circ\text{C}$	$I_{F(AV)}$	2.0							A	
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load(JEDEC Method)	$I_{FSM}$	50							A	
Maximum instantaneous forward voltage at 2A	$V_F$	1.0		1.3		1.7			V	
Maximum DC reverse current @ $T_A=25^\circ\text{C}$ at rated DC blocking voltage @ $T_A=125^\circ\text{C}$	$I_R$	10				350				$\mu\text{A}$
Maximum reverse recovery time at $I_F=0.5\text{A}$ $I_R=1.0\text{A}$ $I_{tr}=0.25\text{A}$	$t_{rr}$	50				75				ns
Typical junction capacitance at 4.0V, 1MHz	$C_J$	50				30				pF
Maximum thermal resistance (NOTE1)	$R_{\theta JA}$ $R_{\theta JL}$	40				15				$^\circ\text{C/W}$
Operating temperature range	$T_J$	-55-----+150							$^\circ\text{C}$	
Storage temperature range	$T_{STG}$	-55-----+150							$^\circ\text{C}$	

NOTE: 1.P.C.B.mounted on 0.2X0.2"(5.0X5.0mm)copper pad area

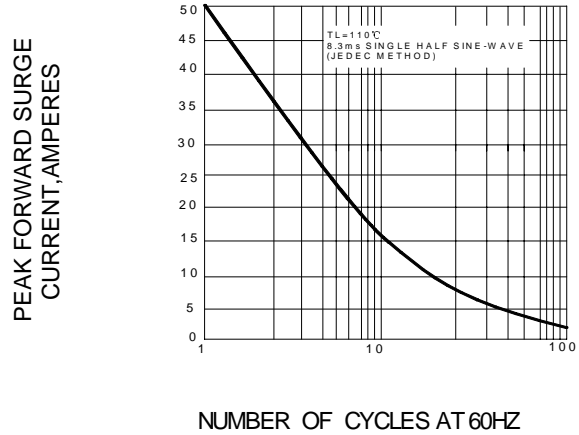


### Ratings AND Characteristic Curves

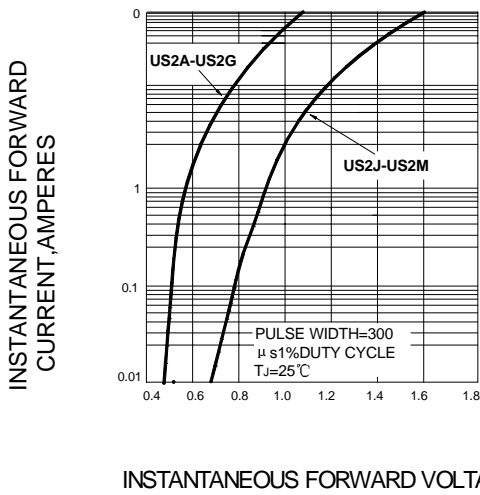
**FIG.1 – FORWARD CURRENT DERATING CURVE**



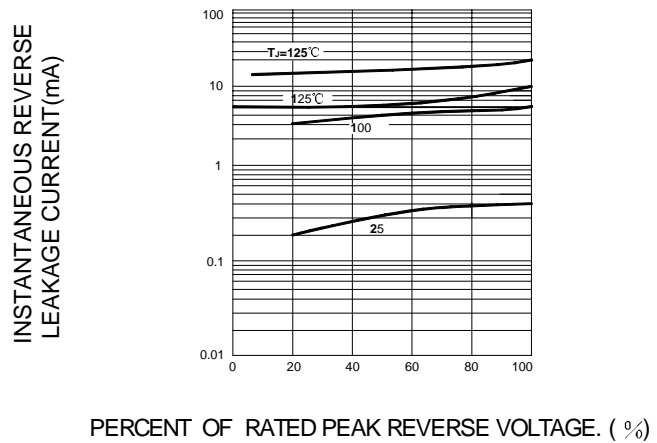
**FIG.2 – MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT**



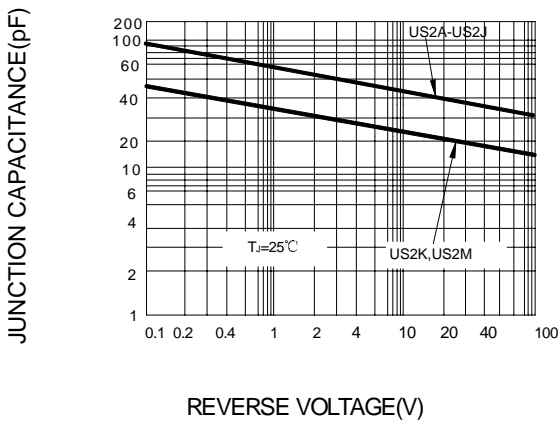
**FIG.3 – TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS**



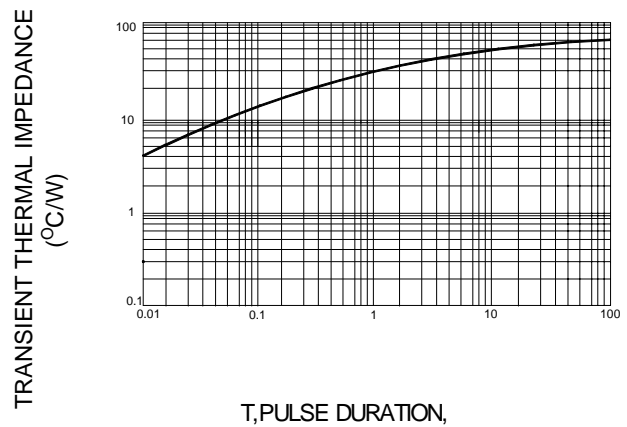
**FIG.4 – TYPICAL REVERSE CHARACTERISTICS**



**FIG.5 – TYPICAL JUNCTION CAPACITANCE**



**FIG.6 – TYPICAL TRANSIENT THERMAL IMPEDANCE**



PACKAGE	SPQ/PCS	CARTON SPQ/PCS	CARTON SIZE/CM	CARTON GW/KG	CARTON NW/KG
SMB	3000/REEL	48000	36X35.8X36.5	12.00	11.00